

# Data sheet

Part number : VXGW1151CA3S-3BXV2-TR



2011/65/EU, (EU)2015/863  
10 Substances regulation compliant



Lead-free solder heat resistant product



Package	SMD top view package, pale blue color emitting LED Outer dimension 1.6 x 0.8 x 0.7mm ( L x W x H )
Product features	<ul style="list-style-type: none"> <li>•Equivalent to JEDEC level 2a</li> <li>•Lead-free soldering compatible</li> <li>•RoHS : 2011/65/EU, (EU)2015/863 compliant</li> </ul>

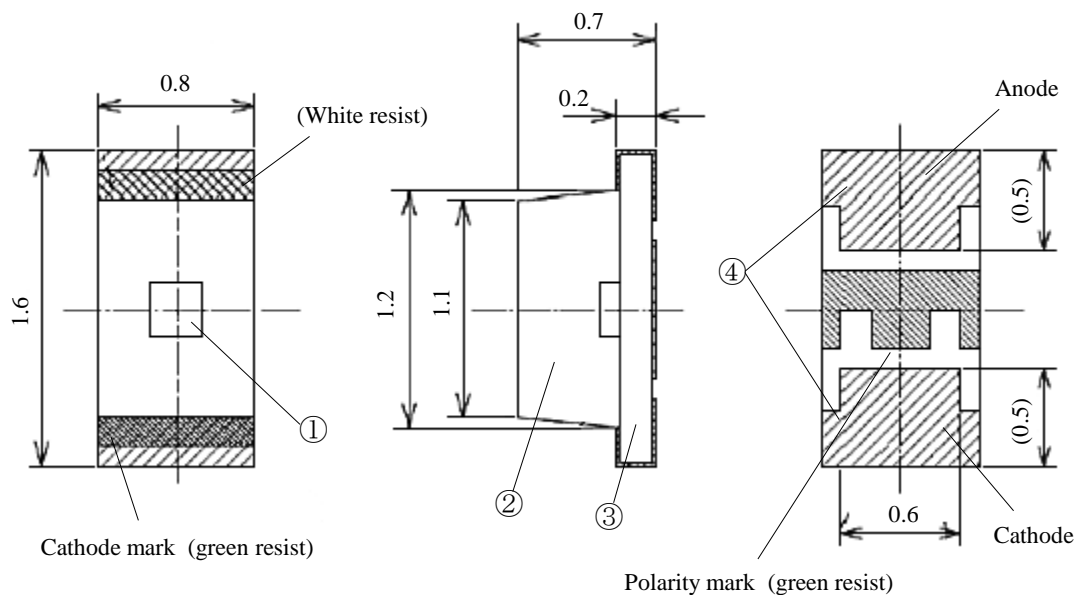
## Recommended applications

- Light source for Automotive interior, various indicators etc.

## Outline dimensions

VXGW1151CA3S-3BXV2-TR

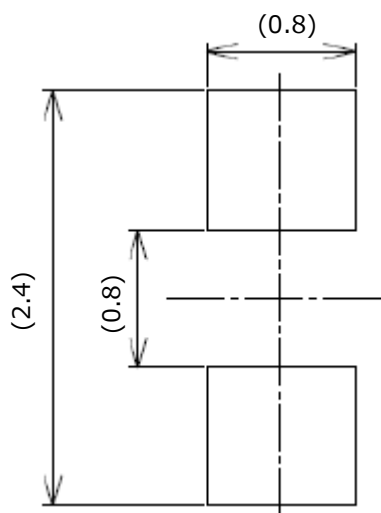
Unit : mm  
 Weight : 1.4mg  
 Tolerance :  $\pm 0.1$



No	Part name	Material	Qty.
①	LED die	InGaN	1
②	Mold resin	Silicone resin	1
③	Substrate	Glass fabrics	1
④	Electrode	Cu/Au	Anode:1 Cathode:1

## Recommended soldering pattern

Unit : mm



※1 The cutting burr size of the substrate and pin doesn't contain it in the size of the height of the product.

※2 Please note no short-circuit when the wiring pattern is arranged between the soldering attachment pad.

Specifications

VXGW1151CA3S-3BXV2-TR

【 Product Overview 】

Die material	InGaN
Emitting color	Pale blue
Resin color 【emitting area】	Diffused pale green

【 Absolute maximum ratings 】

(Ta=25℃)

Item	Symbol	Maximum ratings	Units
Power dissipation	P <sub>d</sub>	70	mW
Forward current	I <sub>F</sub>	20	mA
Repetitive peak forward current "1ms, 1/10duty"	I <sub>FRM</sub>	100	mA
I <sub>F</sub> Derate linearly from "85℃"	ΔI <sub>F</sub>	0.8	mA/℃
I <sub>FRM</sub> Derate linearly from "85℃"	ΔI <sub>FRM</sub>	4.0	mA/℃
Reverse voltage	V <sub>R</sub>	5	V
Operating temperature	T <sub>opr</sub>	-40 to +100	℃
Storage temperature	T <sub>stg</sub>	-40 to +110	℃
Electrostatic discharge threshold "HBM"	ESD	1,000	V
Soldering temperature "reflow soldering"	T <sub>sld</sub>	260	℃
Junction temperature	T <sub>j</sub>	110	℃

Notes1 ESD testing method : EIAJ4701/300(304) Human Body Model(HBM) 1.5kΩ,100pF

Notes2 Please refer to the attached sheets page 6, Soldering Conditions.

Notes1

Notes2

(Ta=25℃)

Item	Symbol	Typ.	Units
Thermal resistance 【Junction - ambient】	R <sub>th(j-a)</sub>	290	℃/W
Thermal resistance 【Junction - solder point】	R <sub>th(j-s)</sub>	140	℃/W

Notes3

Notes3 Rth(j-a) Measurement condition

- Substrate : FR4 ( t=1.6mm )
- Pattern size : 16mm<sup>2</sup>

## Specifications

## VXGW1151CA3S-3BXV2-TR

## 【 Electro-optical characteristics 】

(Ta=25°C)

Item	Symbol	Conditions	Min.	Typ.	Max.	Units	
Forward voltage	$V_F$	$I_F = 10\text{mA}$	2.6	3.0	3.5	V	Note4
Reverse current	$I_R$	$V_R = 5\text{V}$	-	-	10	$\mu\text{A}$	
Luminous intensity	$I_V$	$I_F = 10\text{mA}$	56	70	100	mcd	Note5
Luminous flux	$\Phi_V$	$I_F = 10\text{mA}$	-	(355)	-	mcd	
Chromaticity coordinates	x	$I_F = 10\text{mA}$	-	0.165	-		Note5,6
	y	$I_F = 10\text{mA}$	-	0.122	-		
Half intensity angle	$\Delta\theta X$	$I_F = 10\text{mA}$	-	160	-	deg.	Note7
	$\Delta\theta Y$	$I_F = 10\text{mA}$	-	168	-		

Note4 Tolerance:  $\pm 0.1\text{V}$ 

Note5 Please refer to the attached sheets, each sorting chart.

Note6 Chromaticity coordinates ; x and y according to CIE1931

Note7 Viewing angle at 50%  $I_V$ ,  $\Delta\theta X$  ; housing long side axis,  $\Delta\theta Y$  ; housing short side axis【 Sorting chart for luminous intensity  $I_V$  】

LEDs shall be sorted out into the following chart and each rank parts shall be packed separately when shipping.

Rank	Luminous intensity $I_V$ (mcd)		Condition
	Min.	Max.	
BX	56	68	$I_F = 10\text{mA}$ $T_a = 25^\circ\text{C}$
BY	68	82	
BZ	82	100	

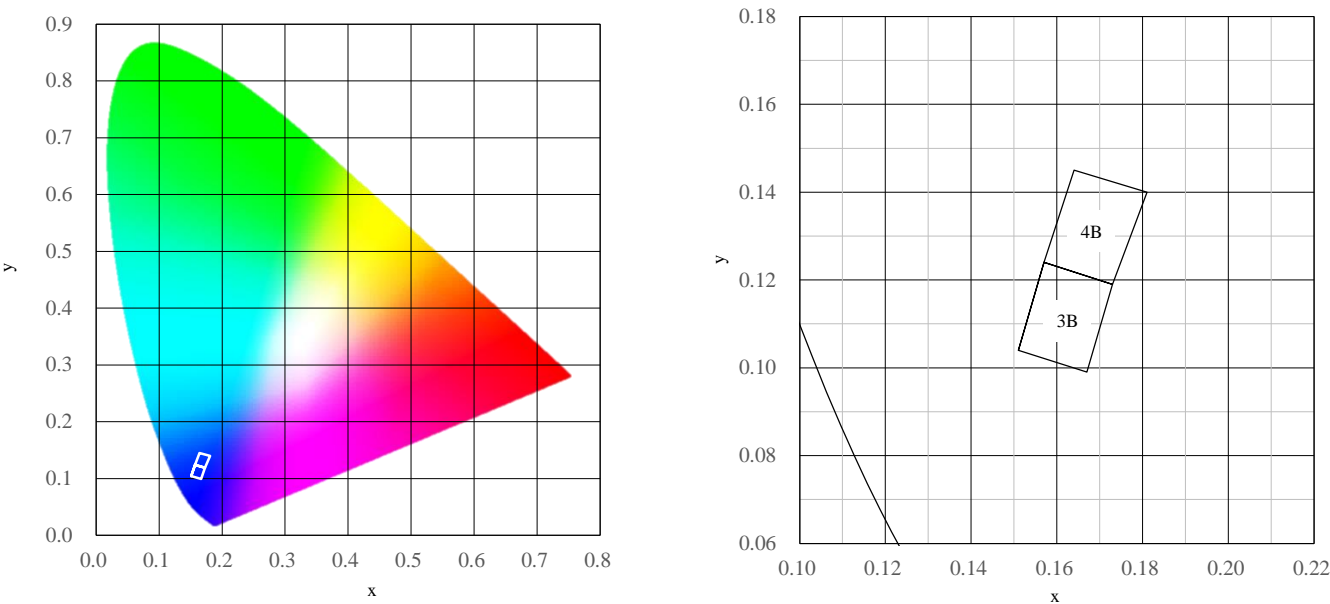
Note : Tolerance each rank:  $\pm 10\%$

Specifications

VXGW1151CA3S-3BXV2-TR

【 Sorting chart for chromaticity coordinates, x,y 】

LEDs shall be sorted out into the following chart and each rank parts shall be packed separately when shipping.



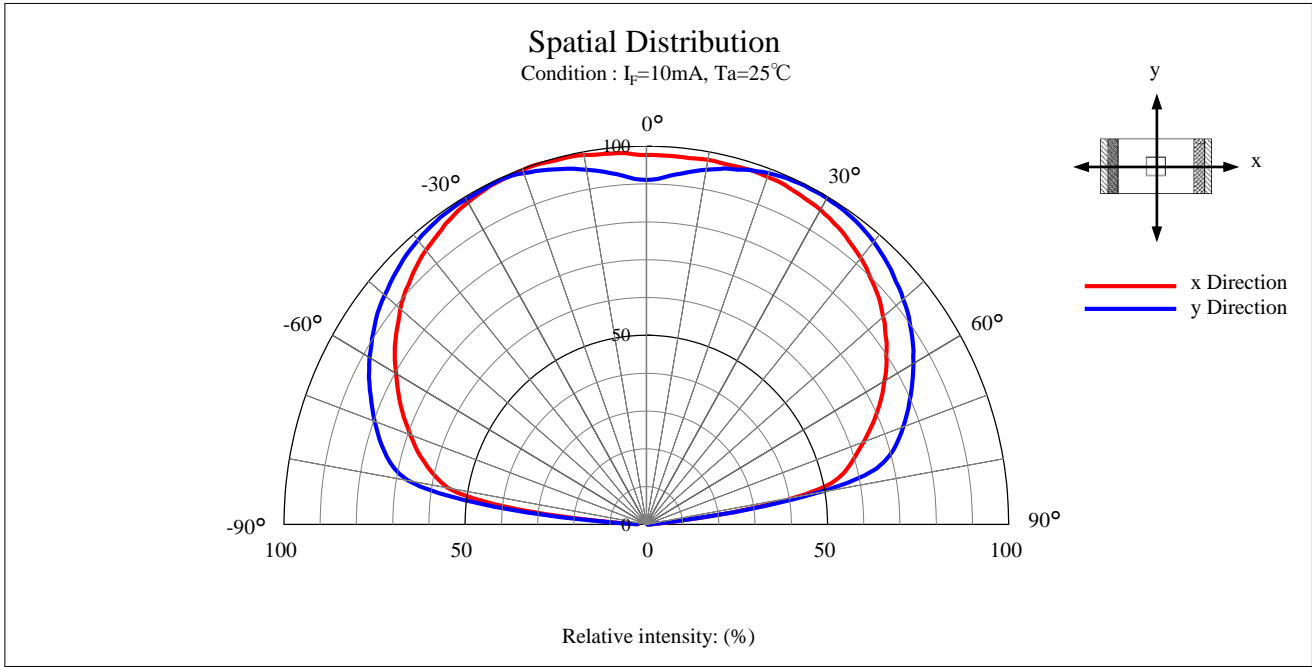
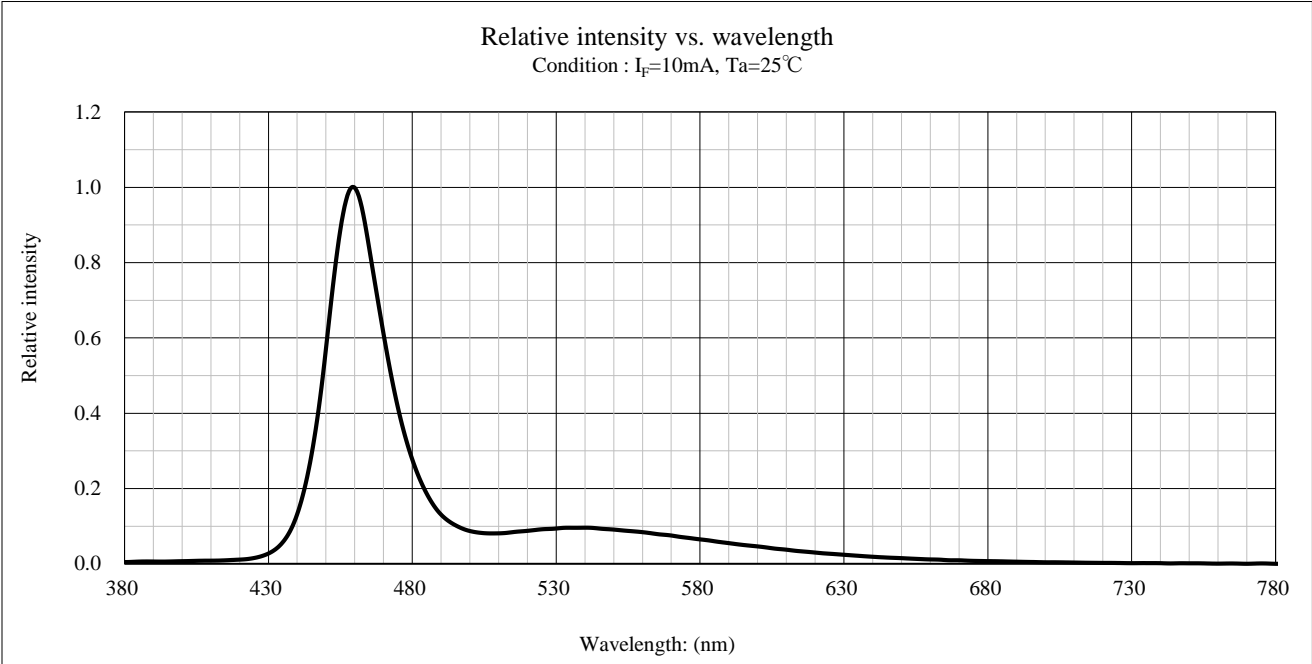
(If=10mA, Ta=25℃)

Rank	Left down		Left upper		Right upper		Right down	
	x	y	x	y	x	y	x	y
3B	0.151	0.104	0.157	0.124	0.173	0.119	0.167	0.099
4B	0.157	0.124	0.164	0.145	0.181	0.14	0.173	0.119

Note Tolerance : ±0.01

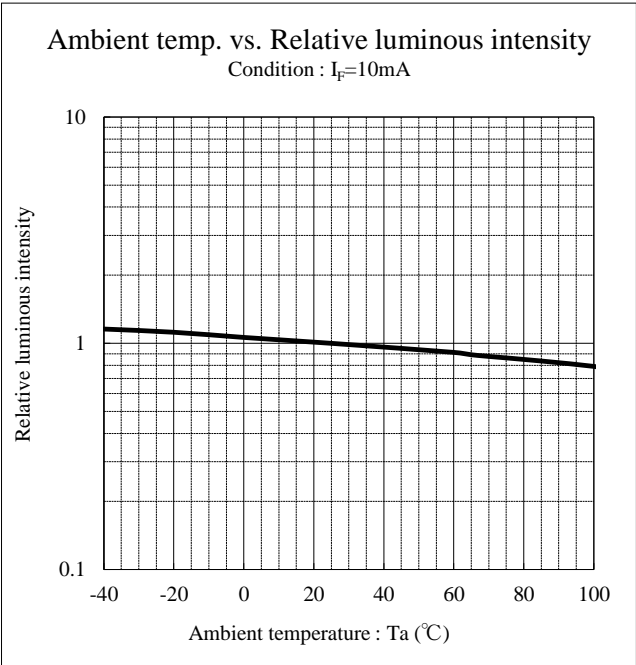
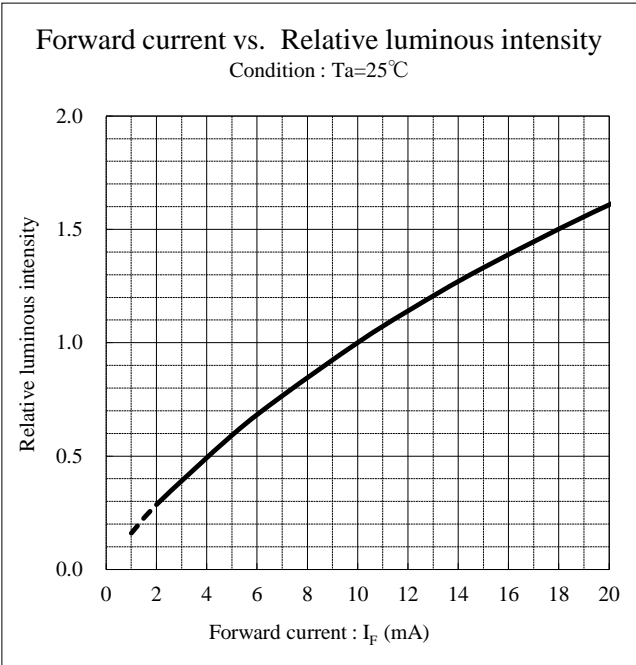
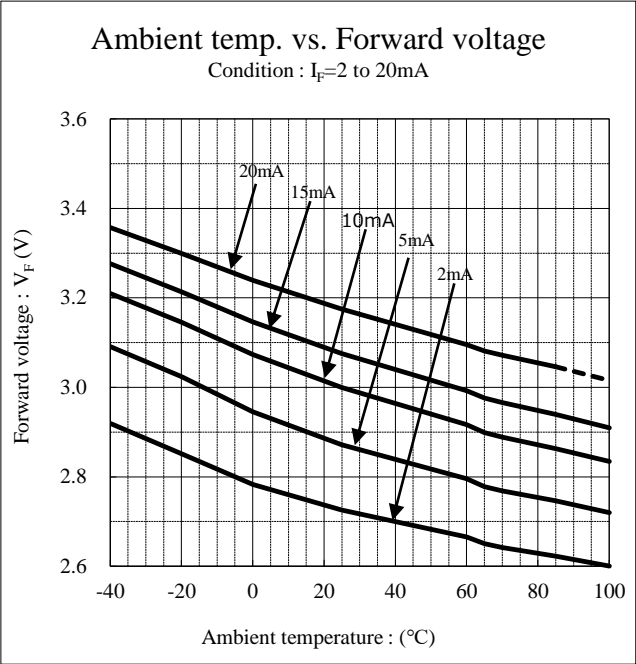
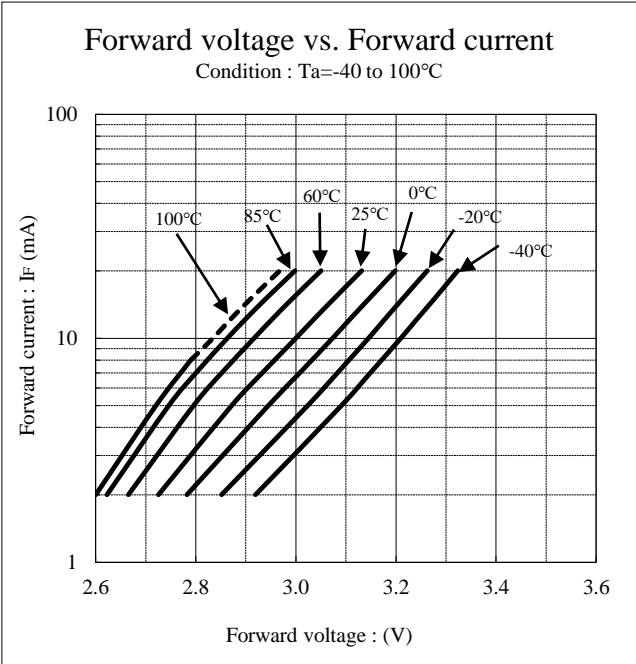
Technical Data

VXGW1151CA3S-3BXV2-TR

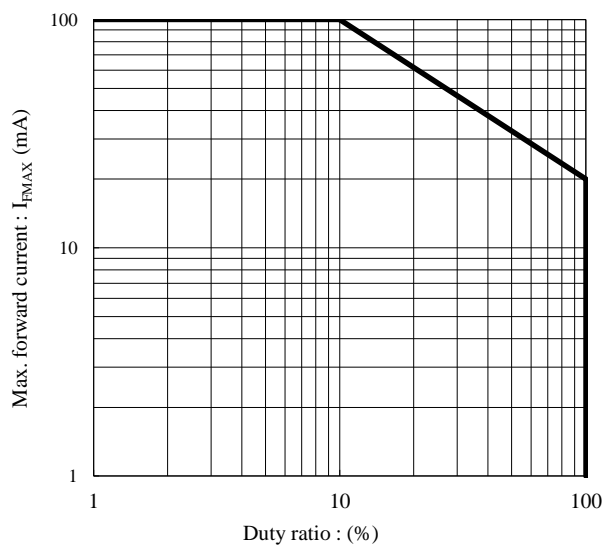
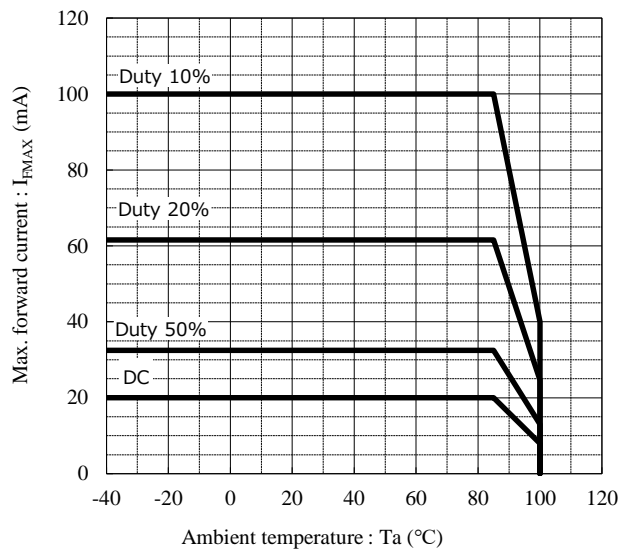
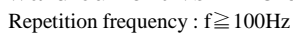
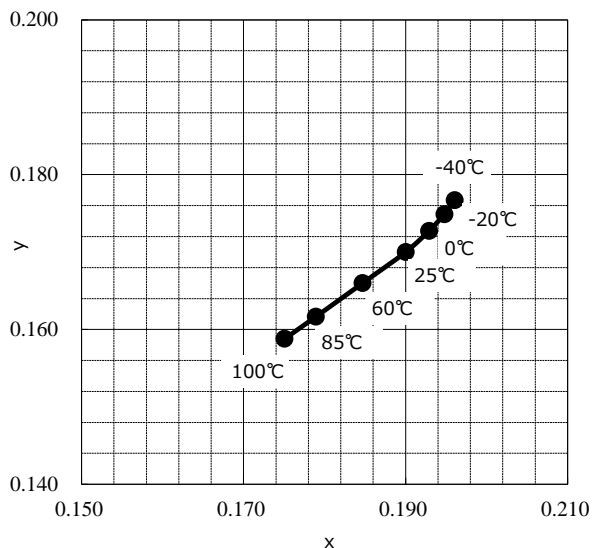
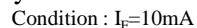
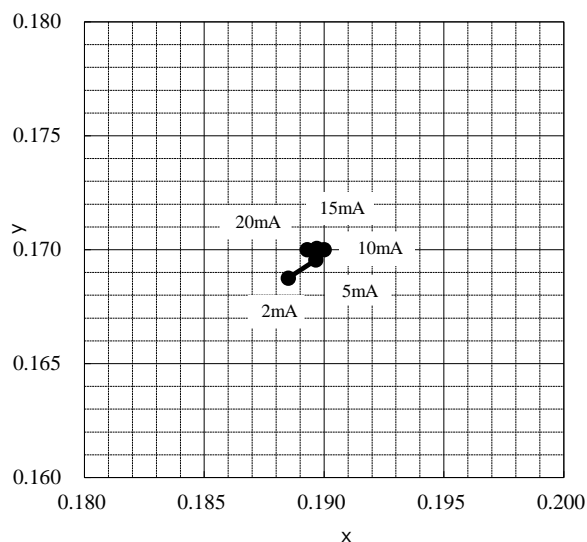
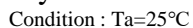


# Technical Data

# VXGW1151CA3S-3BXV2-TR



## VXGW1151CA3S-3BXV2-TR





## Soldering condition

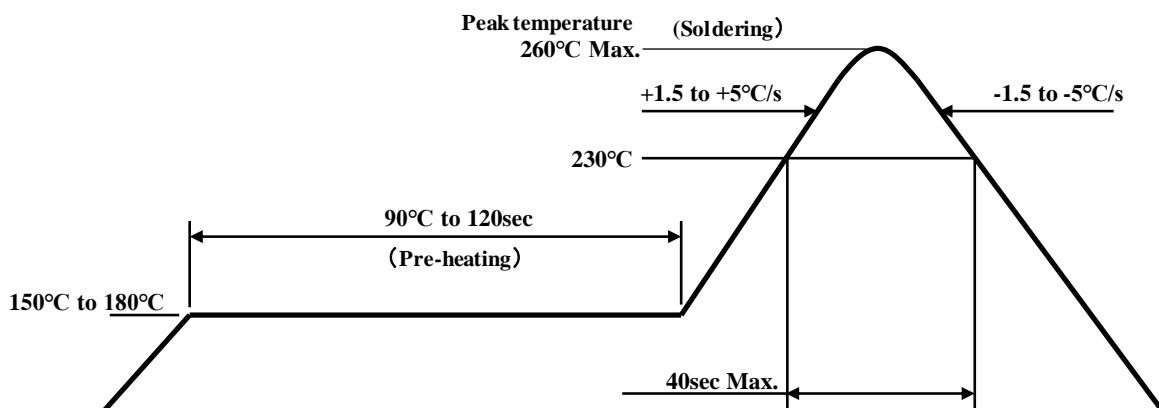
VXGW1151CA3S-3BXV2-TR

### 【Soldering precaution】

(acc.to JEITA-4701/301A(301D))

1. Heat stress during soldering will influence the reliability of LEDs, however that effect will vary on heating method. Also, if components of varying shape are soldered together, it is recommended to set the soldering pad temperature according to the component most vulnerable to heat (e.g., surface mount LED).
2. LED parts including the resin are not stable immediately after soldering ( when they are not at room temperature), any mechanical stress may cause damage to the product. Please avoid such stress after soldering, especially stacking of the boards which may cause the boards to warp and any other types of friction with hard materials.
3. Recommended temperature profile for the reflow soldering is listed as the temperature of the resin surface. Temperature distribution varies on heating method, PCB material, other components in the assembly, and mounting density .  
Please do not repeat the heating process in reflow process more than 2 times.

### 【Recommended reflow soldering condition】



Note 1 Temperature profile for the reflow should be set to the surface temperature of resin which is on the top of LED. This should be the maximum temperature for soldering. Lowering the heating temperature and decreasing heating time is very effective in achieving higher reliability.

Note 2 The reflow soldering process should be done up to 2 times Max. When second process is performed, interval between first and second process should be as short as possible to prevent absorption of moisture to resin of LED. The second soldering process should not be done until LEDs have returned to room temperature (by nature-cooling) after first soldering process.

## Soldering condition

## VXGW1151CA3S-3BXV2-TR

4. If soldering manually, the peak temperature changes according to the size of land and the shape of soldering iron tip. Therefore please confirm there is no problem before usage. Also, Stanley recommends using a soldering iron equipped with temperature control and the peak temperature to be lowered.  
During the actual soldering process, make sure that the soldering iron never touches the LED itself, and avoid the LED's electrode temperature reaching above the temperature of the solder pad.  
All repairs must be performed only once in the same spot, and please avoid reusing components.
5. In soldering process, immediately after iron tip is cleaned, please make sure that the soldering iron reaches the appropriate temperature, then use it. Also, please avoid applying any types of pressure to the soldered components before the solder is cooling and hardening, as it may deteriorate solder performance and solder quality.

### 【Recommended manual soldering condition】

Temperature of iron tip	350°C max.
Soldering duration, time	3sec. max., 1 time

6. When using adhesive material for tentative fixatives, thermosetting resin or Ultraviolet radiation(UV) setting resin with heat shall be recommended.  
The curing condition, Temperature:150°C max. / Time:120sec.max.
7. Flow soldering (dip soldering) is not guaranteed for this product.
8. Please confirm in advance there is no problem by assessment on your side if cleaning process is necessary.  
We can not accept any quality issues caused by the cleaning process.  
As this product uses the low hardness silicone resin for the lens, please avoid cleaning to give pressure on the surface of the resin. Please make sure ultrasonic cleaning is not recommended for this product as well.  
We will recommend isopropyl alcohol as a solvent used for cleaning. Some chemicals, including Freon substitute detergent could corrode the lens or the casing surface, which cause discoloration, cloud, crack and so on.  
Please review the reference chart below for cleaning. If water is used to clean (including the final cleaning process), please use pure water (not tap water), and completely dry the component before using.

Cleaning agents	Recommended / Not recommended
Isopropyl Alcohol	✓ Recommended
Trichloroethylene	x Not recommended
Chloroethene	x Not recommended
Acetone	x Not recommended
Thinner	x Not recommended

9. This products should not be recommended flow soldering(dip soldering).

## Handling precautions

## VXGW1151CA3S-3BXV2-TR

### 【For Electric Static Discharge ( ESD)】

InGaN die LEDs are sensitive to voltage surges generated by On/Off status change and friction with synthetic materials, which may cause severe damage to the die or undermine its reliability.

Damaged products may experience conditions such as extremely high reverse voltage or decrease of forward rise voltage deteriorating their optical characteristic.

Stanley InGaN products are packed with anti-static components.

However, the following precautions must be taken into account upon product shipment.

### 1. Electrification / static electricity protection

In order to avoid product (die) damage from static electricity caused by electrified operator and other materials electrified friction coming in contact with the product, Stanley recommends taking the following precautions.

- ① Do not place electrified non-conductive materials near the LED product.  
Avoid LED products from coming into contact with metallic materials.( Should the metallic material be electrified , the sudden surge voltage will most likely damage the product.)
- ② Avoid a working process which may cause the LED product to rub against other materials.
- ③ Install ground wires for any equipment, where they can be installed, with measures to avoid static electricity surges.
- ④ Prepare a ESD protective area by placing a Conductive Mattress (1MΩ MAX.) and Ionizer to remove any static electricity.
- ⑤ Operators should wear a protective wrist-strap.
- ⑥ Operators should wear conductive work-clothes and shoes.
- ⑦ To handle the products directly, Stanley recommends the use of ceramic, and not metallic, tweezers.

### 2. Working environment

- ① Dry environment is more likely to cause static electricity. Although a dry environment is ideal for storage state of LED products, Stanley recommends an environment with approximately 50% humidity after the soldering process.
- ② Recommended static electricity level in the working environment is less than 150V, which is the same value as Integrated Circuits (which are sensitive to static electricity).

## Handling precautions

## VXGW1151CA3S-3BXV2-TR

### 【 Other precautions 】

1. Stanley LED has semiconductor characteristics and are designed to ensure high reliability. However, the performance may vary depending on usage conditions.
2. Absolute Maximum Ratings are set to prevent LED from failing due to excess stress( temperature, current, voltage, etc.). Usage conditions must not exceed the ratings for a moment, nor do reach one item of absolute maximum ratings simultaneously.
3. In order to ensure high reliability from LED, variable factors that arise in actual usage conditions should be taken it to account for designing. ( Derating of TYP., MAX Forward Voltage, etc.)
4. Please insert Straight Protective Resistors into the circuit in order to stabilize LED operation and to prevent the device from igniting due to excess current.
5. Please check the actual performance in the assembly because the Specification Sheets are described for LED device only.
6. Please refrain from looking directly at the light source of LED at high output, as it may harm your vision.
7. The products are designed to operate without failure in recommended usage conditions. However, please take the necessary precautions to prevent fire, injury, and other damages should any malfunction or failure arise.
8. The products are manufactured to be used for ordinary electronic equipment. Please contact our sales staff beforehand when exceptional quality and reliability are required, and the failure or malfunction of the products might directly jeopardize life or health ( such as for airplanes, aerospace, transport equipment, medical applications, nuclear reactor control systems and so on).
9. It is not recommended supersonic wave welding etc. after mounting the product. There is a possibility of affecting on the junction part in package (junction part of die bonding and wire bonding). Please make sure there is no problem before using.
10. The formal specification sheets shall be valid only by exchange of documents signed by both parties.

## Handling precautions

VXGW1151CA3S-3BXV2-TR

### 【Handling precautions for product mounting】

<Recommendation>

Load : less than 10N  
(to avoid product breakage)

- ※ During mounting, because of the mounter nozzle's load and shape, the lens may break and the shape may change. Therefore, please adjust the load / nozzle adsorption point and the nozzle diameter before use. Moreover, since the occurrence of product remnants of the nozzle part is possible, please adjust the conditions before vacuum break or air discharge.
- ※ Not just the nozzle, but also regarding other tools/instruments/parts, please do not put pressure on the lens.

## Packaging specifications

VXGW1151CA3S-3BXV2-TR

This product is baked (moisture removal) before packaging, and is shipped in moisture-proof packaging (as shown below) to minimize moisture absorption during transportation and storage. However, with regard to storing the products, Stanley recommends the use of dry-box under the following conditions is recommended. Moisture-proof bag as the packaging is made of anti-static material but packaging box is not.

### 【Recommended storage condition / Products warranty period】

Temperature	+5~30°C
Humidity	Under 70%

In the case of the package unopened , 6 months under 【 Recommended storage condition 】.  
Please avoid rapid transition from low temp. condition to high temp. condition  
and storage in corroding and dusty environment.

### 【Time elapsed after package opening】

The package should not be opened until immediately prior to its use, and please keep the time frame between package opening and soldering which is 【Maximum 672h】.

If the device needs to be soldered twice, both soldering operations must be completed within the 672h.

If any components should remain unused, please reseal the package and store them under the conditions described in the 【 Recommended Storage Condition 】 above.

This product must be required to perform baking process (moisture removal) for  
at 10h( MIN.). to 12h(MAX.) at 60±5 degrees Celsius if following conditions apply.

1. In the case of silica gel (blue) which indicates the moisture level within the package, changes or loses its blue color.
2. In the case of time passes for 672h after the package is opened once.

Baking process should be performed after LED having been taken out of the package.

Baking may be performed in the tape-reel form , however if it is performed with the reel stacked over one another, it may cause deformation of the reels and taping materials and later obstruct mounting.

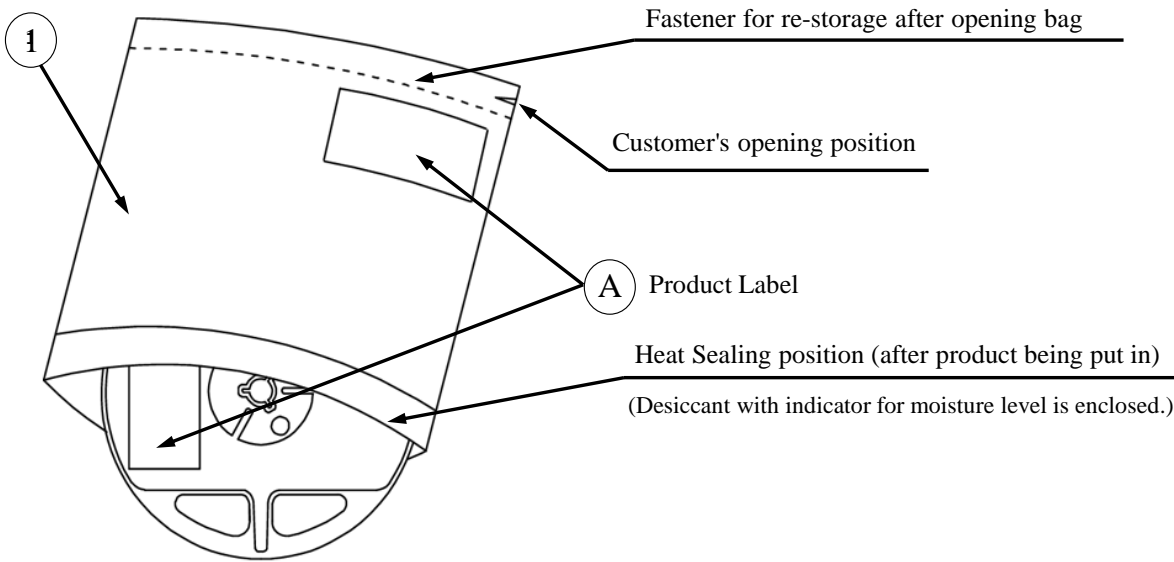
Please handle only once it has returned to room temperature.

Provided that, baking process shall be 2 times Max.

Packaging specifications

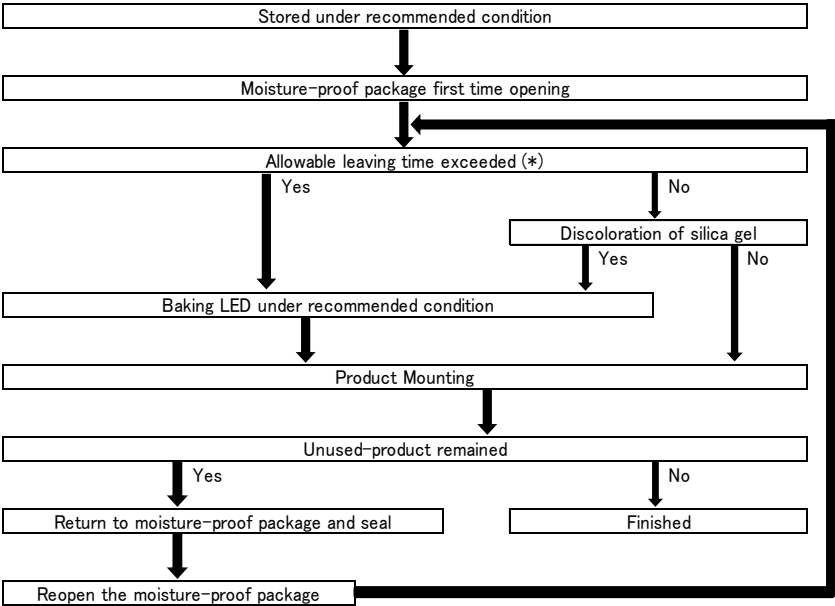
VXGW1151CA3S-3BXV2-TR

【Moisture-proof packaging specification】



No.	Part name	Material	Remarks
①	Moisture-proof bag with aluminum layer	PET+Al+PE	with ESD protection

【Flow chart-package opening to mounting】



Allowable leaving time means the maximum allowable leaving time after opening package, which depends on each LED type.

The allowable leaving time should be calculated form the first opening of package to the time when soldering process is finished.

When judging if the allowable leaving time has exceeded or not, please subtract the soldering time. The allowable leaving time after reopening should be calculated form the first opening of package, or from the time when baking process is finished.

Packaging specifications

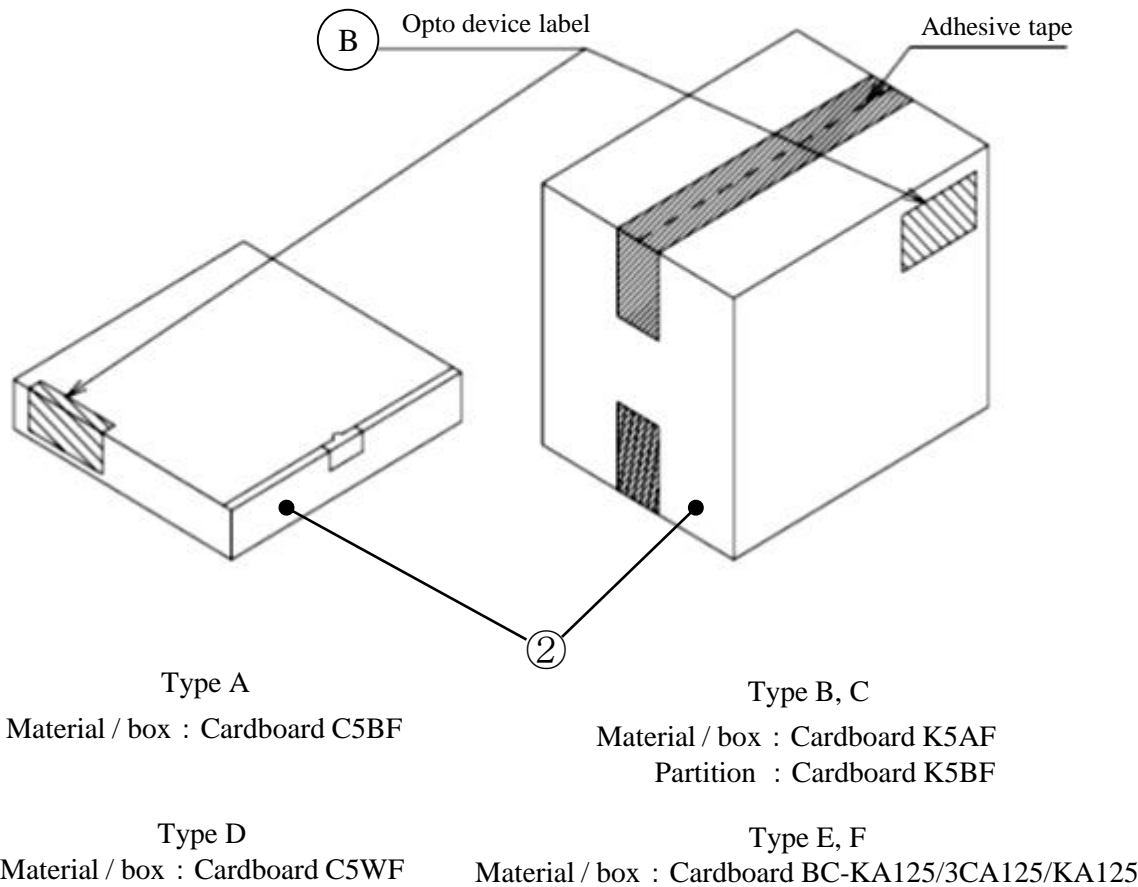
VXGW1151CA3S-3BXV2-TR

【 Packing box 】

(RoHS / ELV compliant)

Box type	Outline dimension L × W × H (mm)	Capacity of the box
Type A	280 × 265 × 45	3 reels
Type B	310 × 235 × 265	15 reels
Type C	440 × 310 × 265	30 reels
Type D	305 × 270 × 65	3 reels
Type E	370 × 280 × 270	30 reels
Type F	530 × 380 × 270	60 reels

The above measurements are reference values.  
The box is selected out of the above table by shipping quantity.



No.	Part name	Material	Remarks
②	Packing box	Corrugated Cardboard	without ESD protection

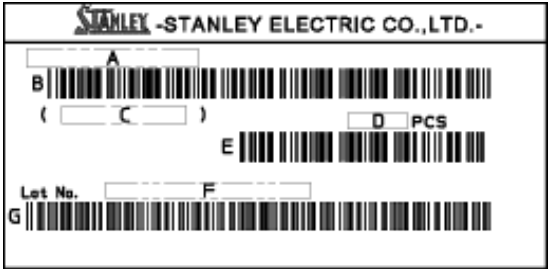


Packaging specifications

VXGW1151CA3S-3BXV2-TR

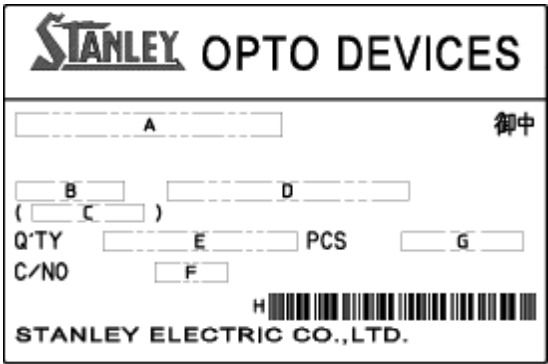
【Label specification】  
( acc.to JIS-X0503(Code-39))

A Product label



- A. Parts number
- B. Bar-code for parts number
- C. Parts code (In-house identification code for each parts number)
- D. Packed parts quantity
- E. Bar-code for packed parts quantity
- F. Lot number & rank  
(refer to lot number notational system for details )
- G. Bar-code for lot number & rank

B Opto device label



- A. Customer name
- B. Parts type
- C. Parts code
- D. Parts number
- E. Packed parts quantity
- F. Carton number
- G. Shipping date
- H. Bar-code for In-house identification number

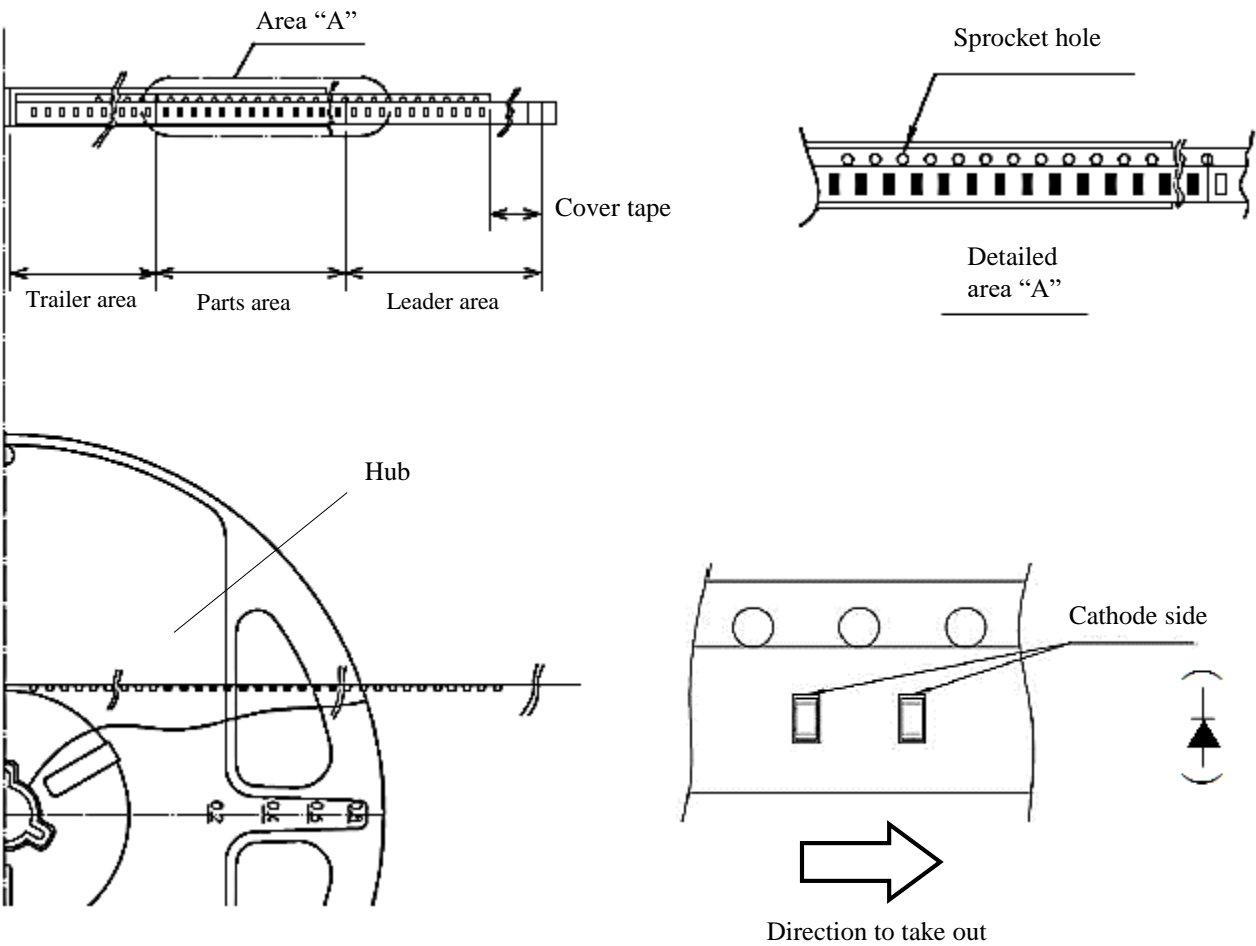
<Remark> Bar-code font : acc.to Code-39(JIS-X0503)

Taping and reel specifications

VXGW1151CA3S-3BXV2-TR

(acc.to JIS-C0806-03)

【Appearance】



Note  
"-TR" means Cathode Side of LEDs should be placed on the sprocket-hole side.

Items		Specifications	Remarks
Leader area	Cover-tape	Cover-tape shall be longer than 300mm without carrier-tape	The end of cover-tape shall be held with adhesive tape.
	Carrier-tape	Empty pocket shall be more than 25 pieces.	Please refer to the above figure for Taping & reel orientation .
Trailer area		Empty pocket shall be more than 40 pieces.	The end of taping shall be inserted into a slit of the hub.

## Taping and reel specifications

## VXGW1151CA3S-3BXV2-TR

(acc.to JIS-C0806-03)

### 【Qty. per reel】

4,000parts/reel

Minimum Qty. per reel might be 500 parts when getting less than 4,000 parts. In such case, parts of 500-unit-qty. shall be packed in a reel and the qty. shall be identified on the label.

### 【Mechanical strength】

Cover-tape adhesive strength shall be 0.1 ~ 1.0N ( An angle between carrier-tape and cover-tape shall be 170 deg. ). Both tapes shall be so sealed that the contained parts will not come out from the tape when it is bent at a radius of 15mm.

### 【Others】

Reversed-orientation, Up-side down placing, side placing and out of spec. parts mix shall not be held. Max qty. of empty pocket per reel shall be defined as follows.

Max, qty. of empty pocket per reel shall be defined as follows.

Qty./Reel	Max.Qty. of empty pocket	Remarks
500	1	-
1,000	1	-
1,500	2	-
2,000	2	No continuance
2,500	3	No continuance
3,000	3	No continuance
3,500	4	No continuance
4,000	4	No continuance

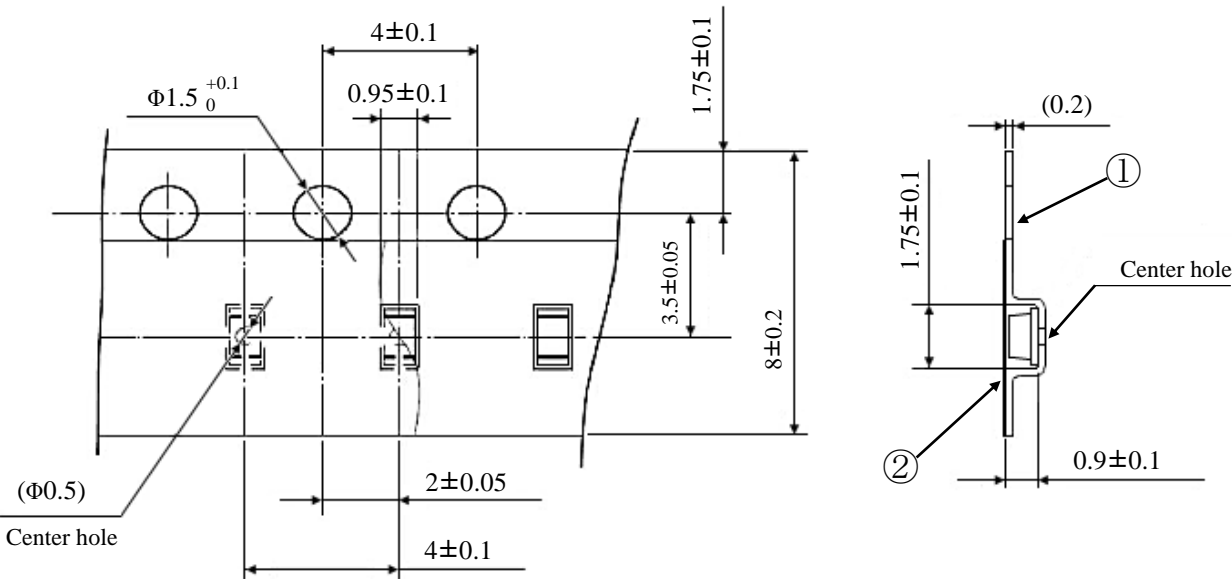
Taping and reel specifications

VXGW1151CA3S-3BXV2-TR

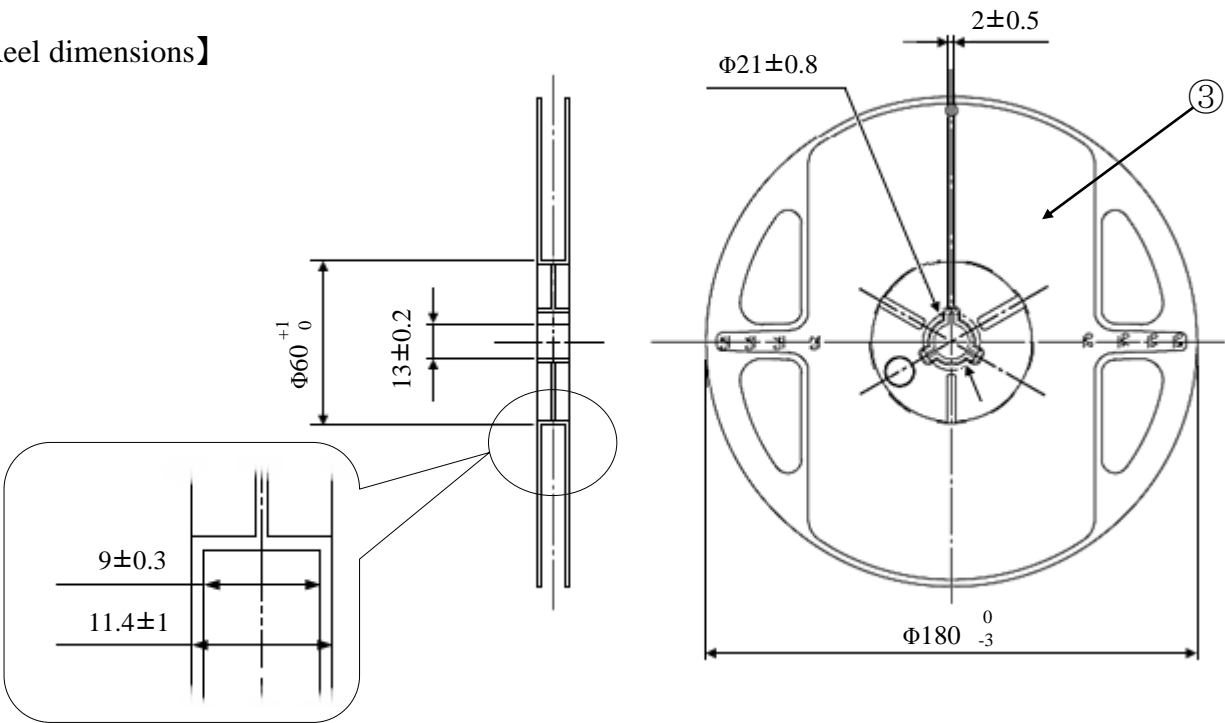
(acc.to JIS-C0806-03)

Unit : mm

【Taping dimensions】



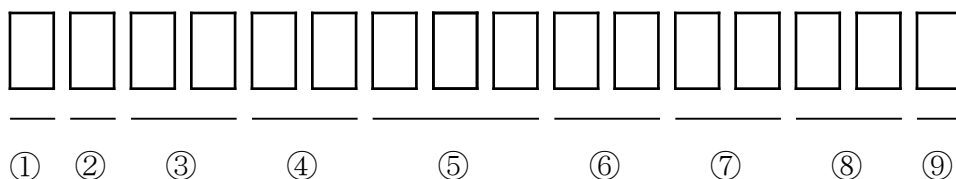
【Reel dimensions】



No.	Part name	Remarks
①	Carrier-tape	Conductive grade
②	Cover-tape	Conductive grade
③	Carrier-reel	Conductive grade

# Lot number notational system

# VXGW1151CA3S-3BXV2-TR



① - 1digit : Production location (mark identify alphabet)

② - 1digit : Production year (The last digit of production year 2025→5, 2026→6, 2027→7, 2028→8 ...)

③ - 2digits : Production month (Jan. to Sep. , should be 01,02,03 ...)

④ - 2digits : Production date

⑤ - 3digits : Serial number

⑥ - 2digits : Tape and reel following number

⑦ - 2digits : Total power rank.

(If total power rank is 1 digit, "-" shall be dashed on the place for the second digit.

If there is no identified rank, "- -" is used to indicate.)

⑧ - 2digits : Color / chromaticity rank

(If color / chromaticity rank is 1 digit, "-" shall be dashed on the place for the second digit.

If there is no identified intensity rank, "- -" is used to indicate.)

⑨ - 1digit : VF rank (If rank is not defined, "-" is described.)

## Compliance with RoHS / ELV

VXGW1151CA3S-3BXV2-TR

This product is in compliance with RoHS / ELV.

Prohibition substance and it's criteria value of RoHS / ELV are as follows.

- RoHS instruction ... Refer to following 1 to 10.
- ELV instruction ... Refer to following 1 to 4.

2011/65/EU, (EU)2015/863

No.	Substance group name	Maximum permissible concentration value
1	Lead and its compounds	1,000ppm (0.1%)
2	Cadmium and its compounds	100ppm (0.01%)
3	Mercury and its compounds	1,000ppm (0.1%)
4	Hexavalent chromium compounds	1,000ppm (0.1%)
5	PBB : Polybrominated Biphenyls	1,000ppm (0.1%)
6	PBDE : Polybrominated Biphenyl Ethers	1,000ppm (0.1%)
7	DEHP : Bis (2-ethylhexyl) phthalate	1,000ppm (0.1%)
8	BBP : Butyl benzyl phthalate	1,000ppm (0.1%)
9	DBP : Dibutyl phthalate	1,000ppm (0.1%)
10	DIBP : Diisobutyl phthalate	1,000ppm (0.1%)

# Reliability testing result

## VXGW1151CA3S-3BXV2-TR

### 1. Reliability testing result

Test item	Standard	Test condition	Duration	Failure
Operating life	EIAJ ED-4701 /100(101)	Ta=25°C Maximum rated current	1,000h	0 / 20
High temperature operating life	EIAJ ED-4701 /100(101)	Ta=85°C Maximum rated current ※1	1,000h	0 / 20
Low temperature operating life	EIAJ ED-4701 /100(101)	Ta=-40°C Maximum rated current	1,000h	0 / 20
Wet high temperature operating life	EIAJ ED-4701 /100(102)	Ta=85°C Rh=85% Maximum rated current	1,000h	0 / 20
High temperature storage life	EIAJ ED-4701 /200(201)	Ta=Tstg max. Maximum storage temperature	1,000h	0 / 20
Low temperature storage life	EIAJ ED-4701 /200(202)	Ta=Tstg min. Minimum storage temperature	1,000h	0 / 20
Wet high temperature storage life	EIAJ ED-4701 /100(101)	Ta=60°C Rh=90%	1,000 cycles	0 / 20
Thermal shock	EIAJ ED-4701 /100(105)	Ta=Tstg max. to Tstg min. (each 15min)	1,000 cycles	0 / 20
Resistance to reflow soldering	EIAJ ED-4701 /300(301)	Moisture soak : 60°C 60% 121h Preheating : 150 to 180°C 90 to 120s soldering : 260°C 5sec	2 times	0 / 20
Electric Static Discharge(ESD) ※2	EIAJ ED-4701 /300(304)	C=100pF R2=1.5kΩ ±2,000V	3 times of each polarity	0 / 10
Vibration, variable frequency	EIAJ ED-4701 /400(403)	98.1m/s <sup>2</sup> (10G) 100 to 2,000Hz 20min sweep XYZ direction	2h of each direction	0 / 10

※1 Maximum rated current at maximum rated operating temperature

※2 Reference test

### 2. Failure criteria

Item	Symbol	Condition	Failure criteria
Luminous intensity	I <sub>V</sub>	I <sub>F</sub> value of each product luminous intensity	Testing min. value < Standard min. value × 0.5
Forward voltage	V <sub>F</sub>	I <sub>F</sub> value of each product forward voltage	Testing max. value ≥ Standard max. value × 1.2
Reverse current	I <sub>R</sub>	V <sub>R</sub> =5V	Testing max. value ≥ Standard max. value × 2.5
Cosmetic appearance	-	-	Notable, decoloration, deformation and cracking

## VXGW1151CA3S-3BXV2-TR

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